

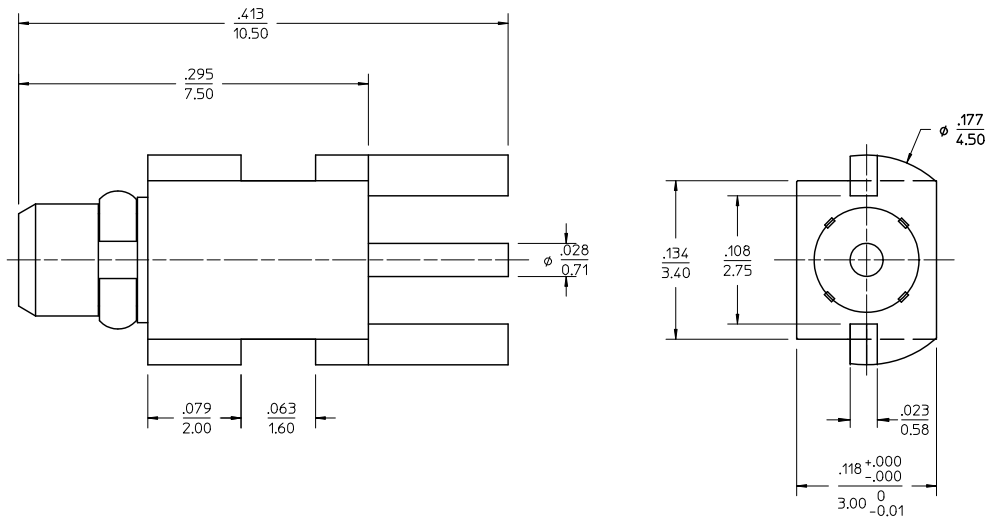
10 9 8 7 6 5 4 3 2 1

MATERIALS AND FINISHES

BODY, CONTACT: BRASS
PLATED GOLD

INSULATOR
TEFLON

SNAP RING: BERYLLIUM COPPER
PLATED GOLD



ES-73599-0000-0150	INTERFACE DIMENSION	73415-1271	PER COMMERCIAL REQUIREMENTS
PS-89675-1910	ELECTRO/MECH PERFORMANCE	73415-1270	PER MILITARY REQUIREMENTS
SPECIFICATION	DESCRIPTION	PART NUMBER	DESCRIPTION

CHG: DELETE PLATING THICKNESS EC NO: URF2010-0347 DRWN: JWIENER 2009/12/28 CHKD: SSHAH 2009/12/28 APPR: JWIENER 2009/12/28 REV: D1	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM	SCALE 12:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		4 PLACES ± --- ± ---	mm INCH	DRAWN BY LYNN	DATE 2000/01/31	TITLE MMCX PLUG 50 OHM EDGE LAUNCHER MMCX -P/PCB		
		3 PLACES ± --- ± ---	± 0.05 ± ---	CHECKED BY JERRY	DATE 2000/01/30	MOLEX INCORPORATED		
		2 PLACES ± 0.10 ± ---	ANGULAR ± 2 °	APPROVED BY MISEN	DATE 2000/01/31	MATERIAL NO. SEE TABLE	DOCUMENT NO. SD-73415-127	SHEET NO. 1 OF 01

fb_frame_A3_P_ME_T
Rev. D 2004/04/02

9 8 7 6 5 4 3 2 1